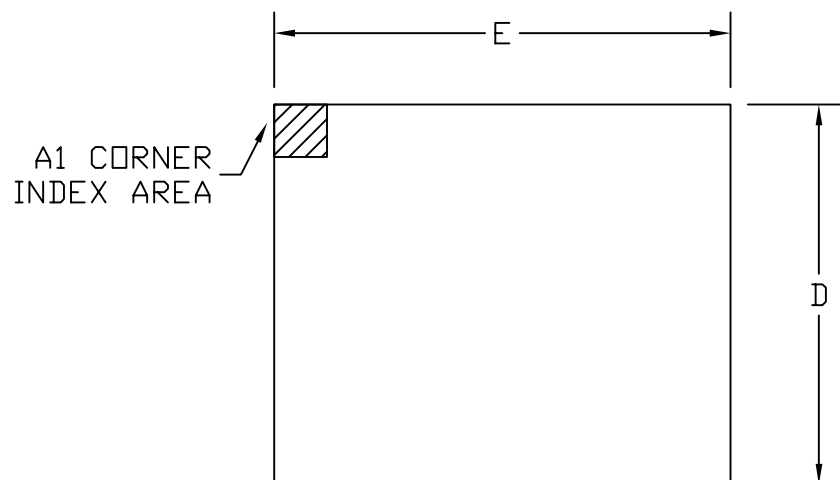
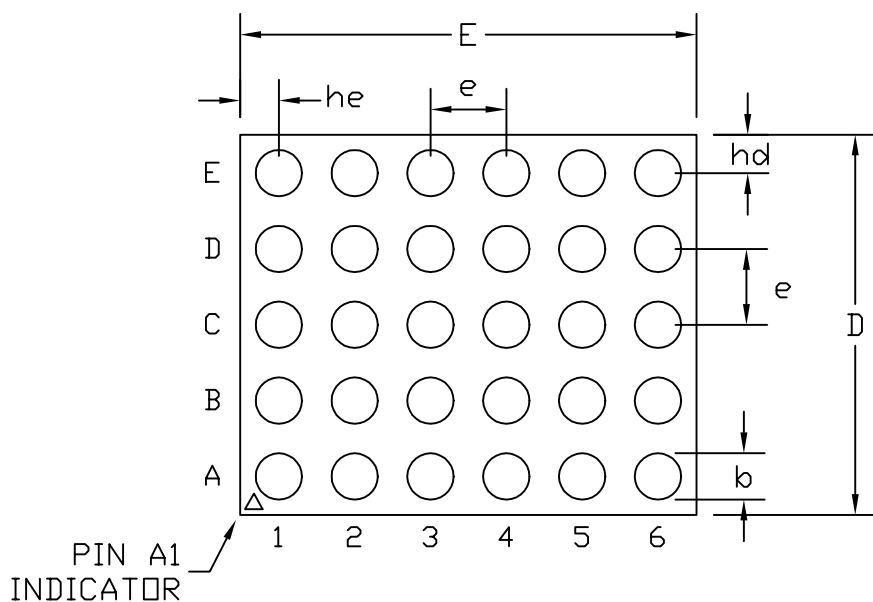




TOP VIEW

SYMBOL	DIMENSIONS
A	0.60±0.05
D	2.52±0.05
E	3.02±0.05
e	0.50 BASIC
b	∅ 0.35 BASIC
A1	0.27±0.04
A2	0.33 Ref.
hd	0.26 Ref.
he	0.26 Ref.

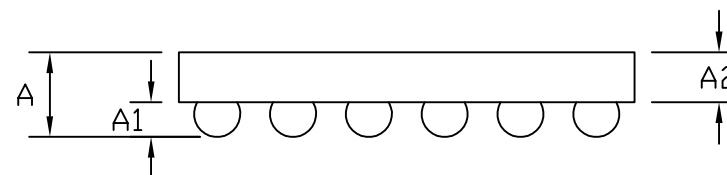
SOLDER BALL DEPOPULATION	
PKG. CODE	DEPOPULATED BALL
B30-1	NONE
B30-2	B4, C1, C4, D4
B30-3	B2, B3, B4 C2, C3, C4 D2, D3, D4, D5
B30-4	B3, B4 C2, C3, C4, C5 D3, D4



BOTTOM VIEW

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MEETS JEDEC M0195.



SIDE VIEW

MAXIM			
PROPRIETARY INFORMATION			
TITLE: PACKAGE OUTLINE, 6x5 UCSP			
APPROVAL	DOCUMENT CONTROL NO. 21-0123	REV. C	1/1